



### DESCRIPTION:

The products are 6-pin solid-state relay opto-couplers. The device combines an AlGaAs infrared emitting diode as the emitter which is optically coupled to a monolithic silicon random-phase photo triac to drive a power triac in a plastic DIP6 package with different lead forming options. The products are widely used in solenoid/valve controls, lighting controls, motor controls, temperature controls, static AC power switches, solid state relays, interfacing microprocessors to 265 V<sub>AC</sub> peripherals.

### MAIN FEATURES

- High isolation 5000 Vrms
- DC input with triac output
- Operating temperature range - 40°C to 110 °C
- REACH & RoHS compliance
- HBM: H3B; MM: M4; CDM: C3
- CQC approved
- VDE approved
- UL approved

### ABSOLUTE MAXIMUM RATINGS (Temperature=25°C)

| Parameter |  | Symbol               | Value | Unit  |
|-----------|--|----------------------|-------|-------|
| Input     | Forward Current  | I <sub>F</sub>       | 50    | mA    |
|           | Peak Forward Current   | I <sub>FP</sub>      | 1     | A     |
|           | Reverse Voltage  | V <sub>R</sub>       | 6     | V     |
|           | Power Dissipation  | P <sub>D</sub>       | 75    | mW    |
| Output    | Repetitive peak off-state voltage  | V <sub>DRM</sub>     | 600   | V     |
|           | Repetitive peak off-state voltage  | V <sub>RRM</sub>     | 600   | V     |
|           | Critical rate of rise of on-state current                                      | di/dt                | 100   | A/μs  |
|           | On-state RMS Current (T <sub>a</sub> 43 °C)                                    | I <sub>T(RMS)</sub>  | 0.6   | A     |
|           | Non repetitive surge peak on-state current (full cycle , t <sub>p</sub> =20ms) | I <sub>TSM</sub>     | 6     | A     |
|           | junction to case (AC)  | R <sub>th(j-c)</sub> | 65    | /W 6A |



|  |           |         |      |
|--|-----------|---------|------|
| Isolation Voltage  | $V_{iso}$ | 5000    | Vrms |
| Operating Temperature  | $T_{opr}$ | -40~110 |      |
| Junction Temperature   | $T_j$     | 125     |      |
| Storage Temperature  | $T_{stg}$ | -40~125 |      |
| Soldering Temperature  | $T_{sol}$ | 260     |      |
| Peak pulse voltage<br>( $T_j=25$ ; non-repetitive,off-state) | $V_{pp}$  | 3       | kV   |

**NOTE1:** 100 $\mu$ s pulse, 100Hz frequency

**NOTE2:** AC for 1minute, R.H.=40~60%

**ELECTRICAL CHARACTERISTICS** (Temperature=25°C)

| Parameter |                 | Symbol | Condition  | Min. | Typ. | Max. | Unit    |
|-----------|-----------------|--------|------------|------|------|------|---------|
| Input     | Forward Voltage | $V_F$  | $I_F=10mA$ | -    | 1.2  | 1.5  | V       |
|           | Reverse Current | $I_R$  | $V_R=6V$   | -    | -    | 1    | $\mu A$ |

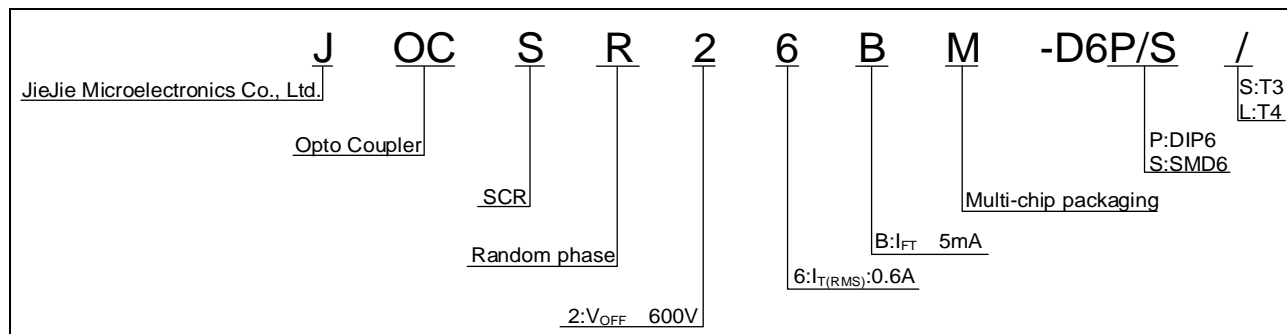
Peak Off-state  
Current, Either  
Direction

$I_{DRM1}$   
Direction

=

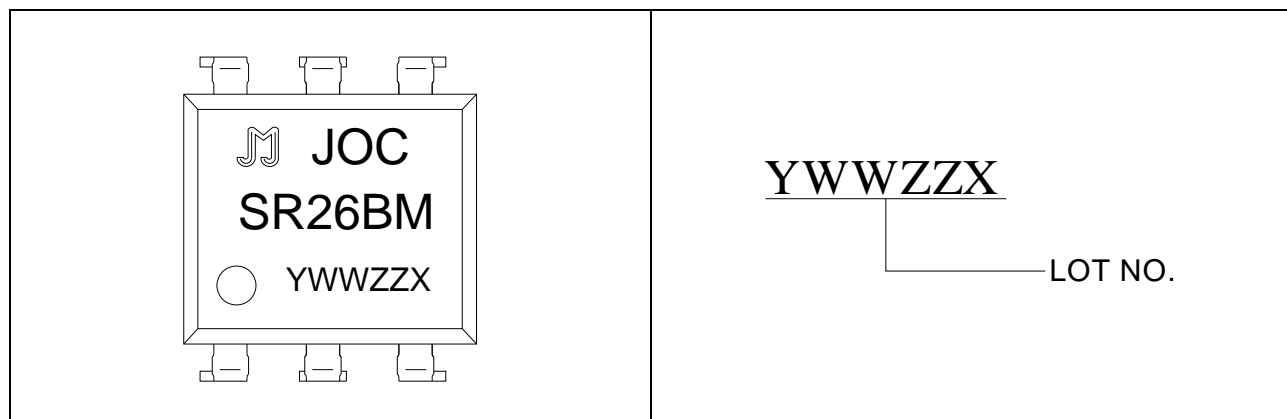
Output

ORDERING INFORMATION



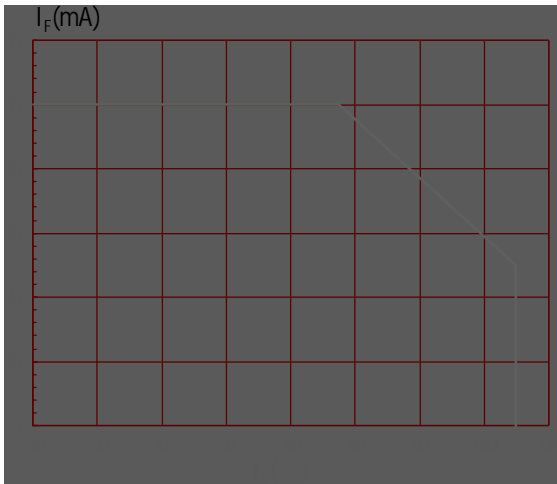
| Packing Quantity |                 |
|------------------|-----------------|
| Option           | Quantity        |
| DIP              | 60 Units/Tube   |
| SMD              | 1200 Units/Reel |

MARKING

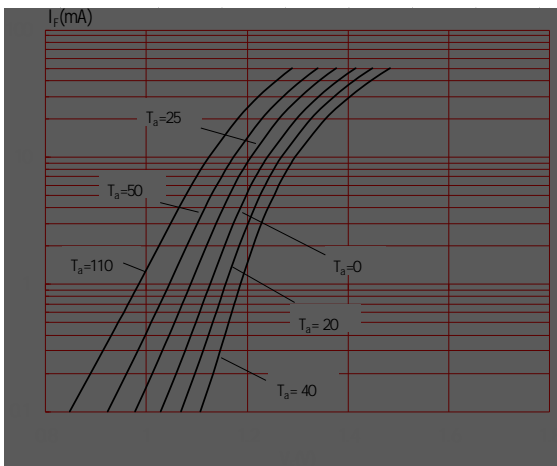


Characteristics Curves

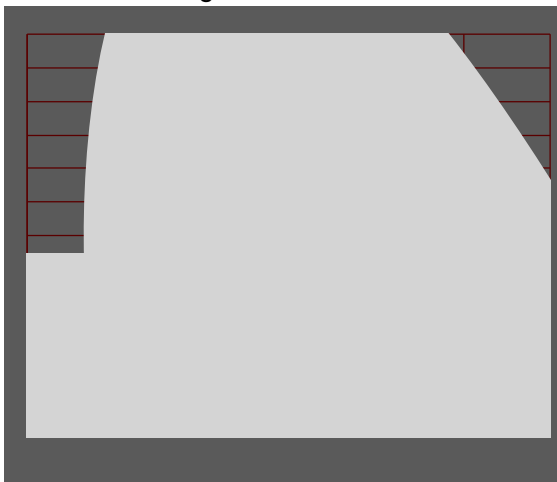
**FIG.1:** Max. Allowable LED Forward Current vs. Ambient Temperature



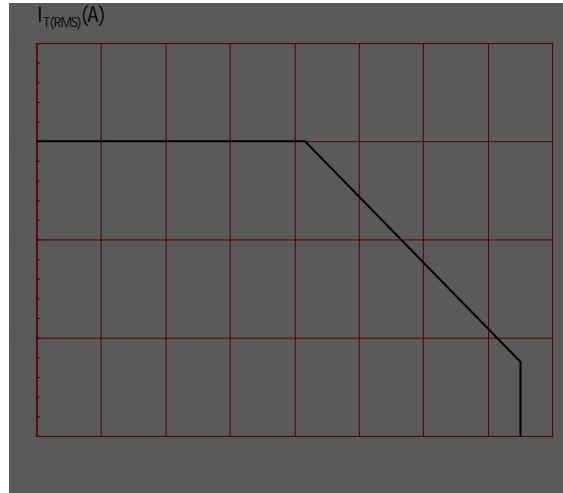
**FIG.3:** Forward Current vs. Forward Voltage



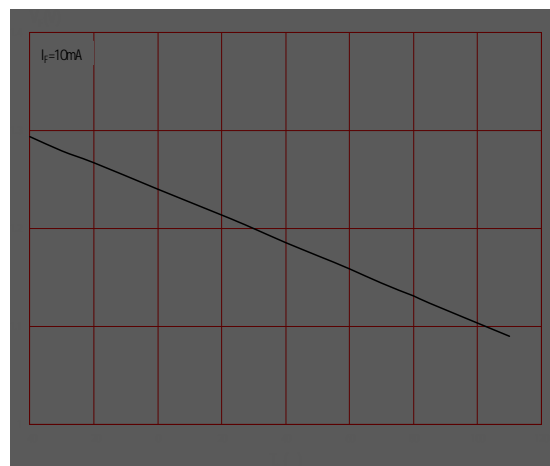
**FIG.5:** Off-state Terminal Current vs Off-state Terminal Voltage



**FIG.2:** On-state Terminal Current vs. Ambient Temperature

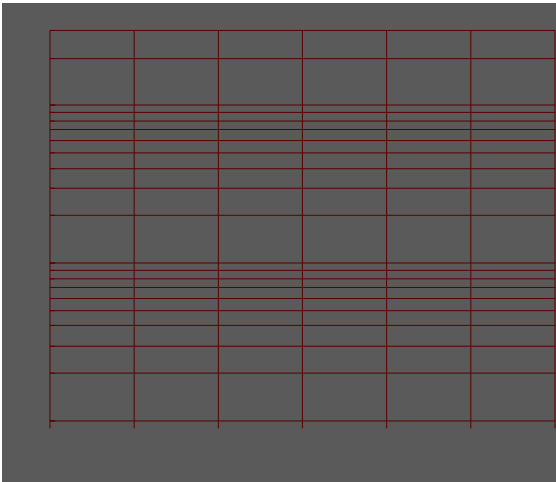


**FIG.4:** Forward Voltage vs. Ambient Temperature





**FIG.7:** On-state characteristics



**FIG.8:** Normalized Holding Current vs. Ambient Temperature

TEST CIRCUITS

FIG.10: Test Circuits of Turn On Time

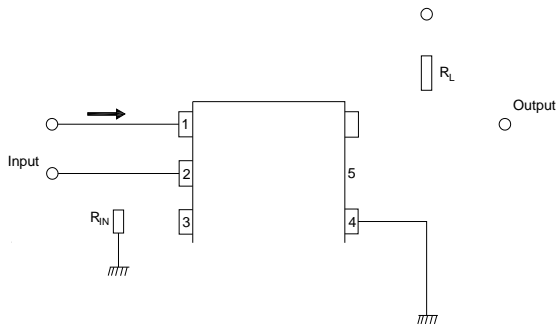
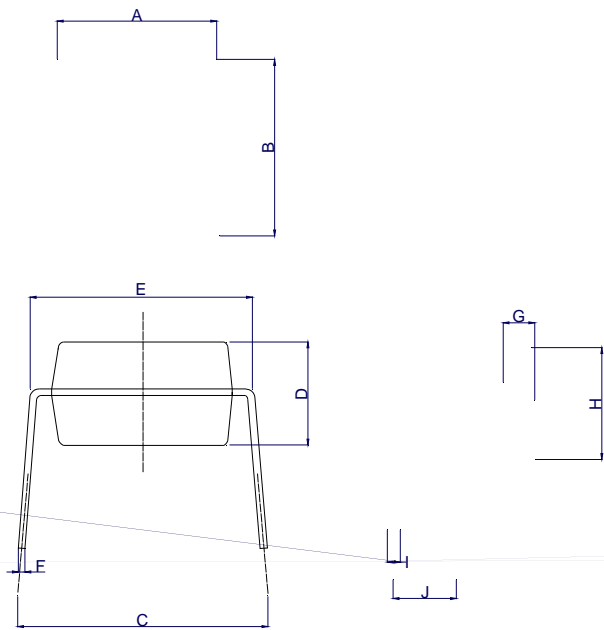


FIG.11: Waveforms of Turn On Time

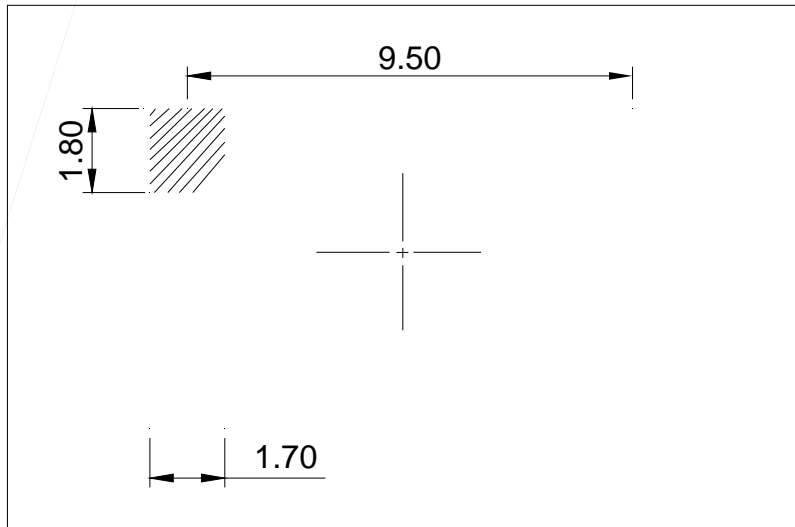
Package Dimension (Unit: mm)

Standard DIP Type:



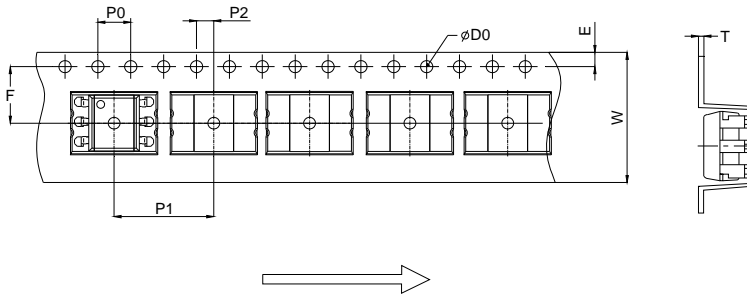
RECOMMENDED SOLDER MASK (Dimensions in mm unless otherwise stated)

Option SMD



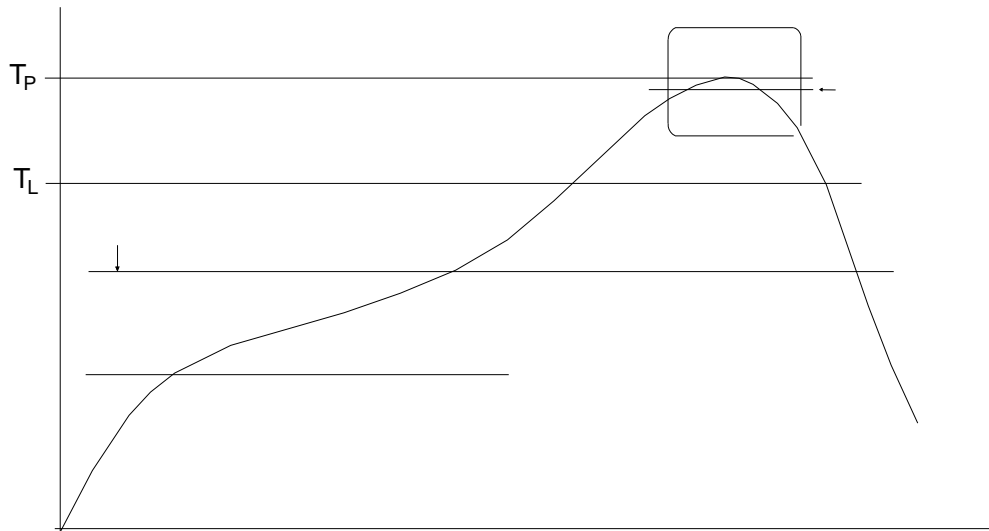
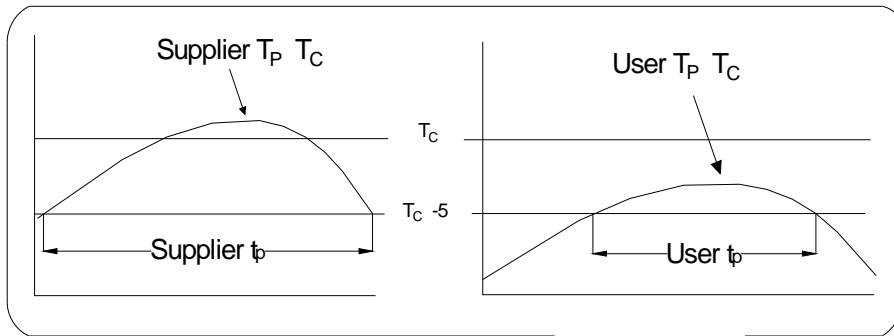
CARRIER TAPE SPECIFICATIONS (Dimensions in mm unless otherwise stated)

Option S/L

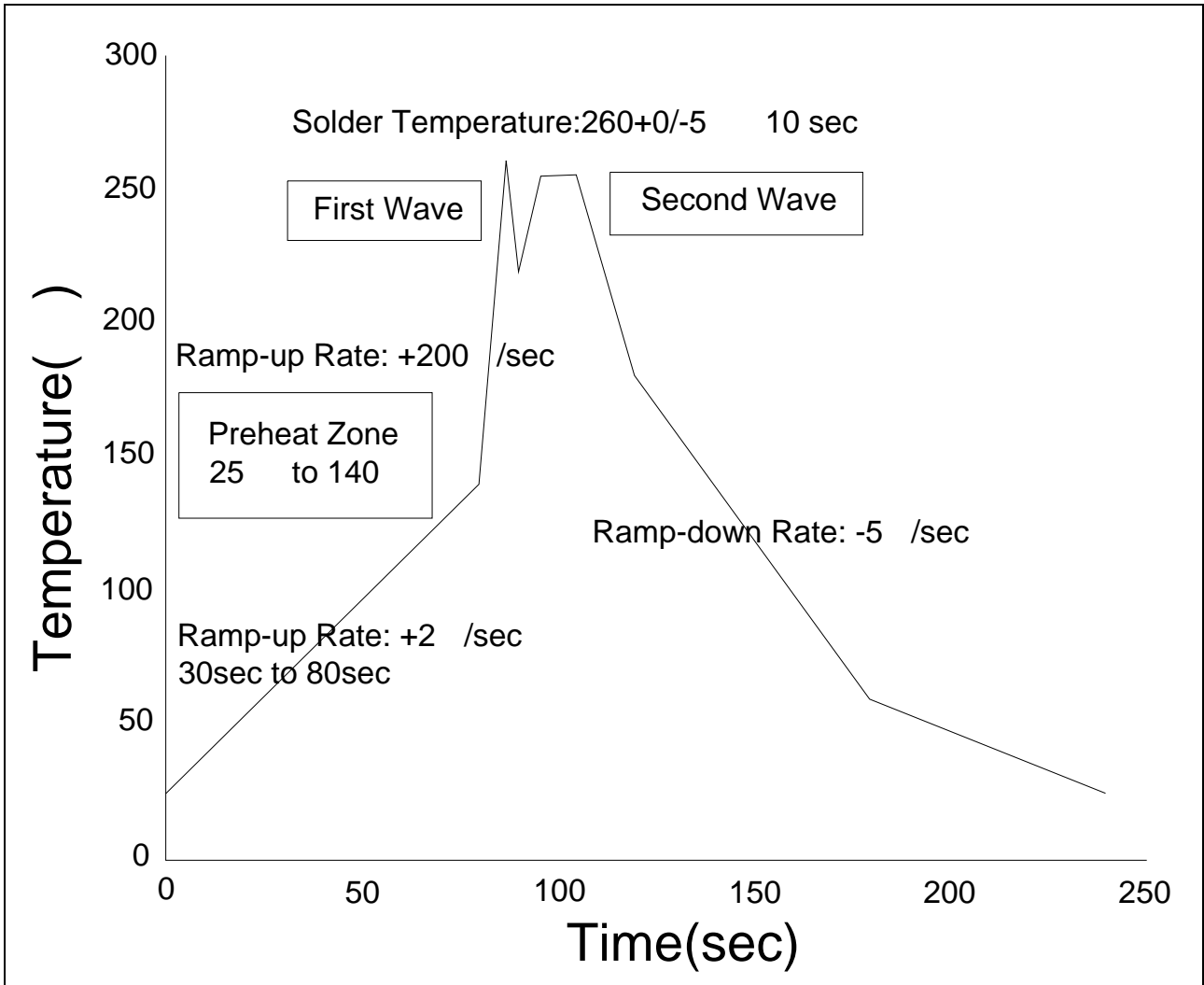


| Ref. | Dimensions  |       |       |        |       |       |
|------|-------------|-------|-------|--------|-------|-------|
|      | Millimeters |       |       | Inches |       |       |
|      | Min.        | Typ.  | Max.  | Min.   | Typ.  | Max.  |
| D0   |             | 1.50  | 1.60  |        | 0.059 | 0.063 |
| P0   | 3.90        | 4.00  | 4.10  | 0.154  | 0.157 | 0.161 |
| P1   | 11.90       | 12.00 | 12.10 | 0.469  | 0.472 | 0.476 |
| P2   | 1.90        | 2.00  | 2.10  | 0.075  | 0.079 | 0.083 |
| E    | 1.65        | 1.75  | 1.85  | 0.065  | 0.069 | 0.073 |
| F    | 7.40        | 7.50  | 7.60  | 0.291  | 0.295 | 0.299 |
| T    | 0.35        | 0.40  | 0.45  | 0.014  | 0.016 | 0.018 |
| W    | 15.70       | 16.00 | 16.30 | 0.618  | 0.630 | 0.642 |

REFLOW INFORMATION



WAVE SOLDERING



HAND SOLDERING BY SOLDERING IRON


|                       |         |
|-----------------------|---------|
| Soldering Temperature | 360± 5  |
| Soldering Time        | 3s max. |

Note:

1. Reflow soldering is recommended at the temperatures and times shown, no more than three times.
2. Avoid direct contact between the epoxy body and any tools or surfaces exceeding its maximum storage temperature.
3. Application of pressure on the epoxy body is prohibited at elevated temperatures. In specific scenarios, any applied force must not exceed 2.5N.
4. Ensure the component has cooled to ambient temperature before proceeding with any subsequent manufacturing steps.
5. The component has a shelf life of one year when stored under standard conditions.
6. Recommend storage Temp.: 0~40°C;  
Recommend storage humidity: <60%;  
MSL level: MSL 1

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